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89HPES16T16ZABL

Category:	
Generic Part:	89HPES16T16
Market Group:	SSP
Description:	PCIE 64-LANE 16 PORT SWIT

Time is money
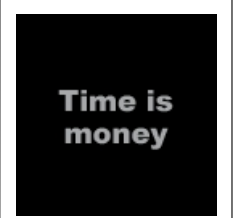
Parameters

Speed	NA
Temperature	C
Voltage	1.0 V
Status	Active
Sample	Yes
Minimum Order Quantity	1
Factory Order Increment	1

Distributor Inventory

No Pricing information is available from our Distributors at this time.

Documents

Type	Title	Size	Revision Date
Application Note	AN-531, PCIe System Interconnect Software Architecture	155 KB	03/19/2007
	AN-571, PCIe System Interconnect SW Architecture for x86-based Systems	187 KB	05/22/2007
	AN-572, Upstream Port Redundancy & Failover for System Interconnect Switches	177 KB	05/24/2007

Package

Package	FCBGA 1156 (BL1156)
Description	FLIP CHIP BGA 35 X 35 MM X 1.0MM PITCH
Status	Active
Class	PLASTIC
Category	Standard
Pb (Lead) Free	No
Mark	BL
Package Type	FCBGA
Lead Count	1156
Length	35.0 mm
Width	35.0 mm
Thickness	2.82 mm
Pitch	1.0 mm
Tube / Tray	TRAY
Quantity per Tube/Tray	24
Quantity per Reel	N/A
Moisture Sensitivity Level (MSL)	4
Moisture Exposure Floor Life	72 hrs@<30C/60%RH
Peak Reflow Temperature	225Â°C
Rebake Conditions	48hrs@125C
Related Package Documents	view documents